### SN74CB3T16211 24-BIT FET BUS SWITCH 2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V TOLERANT LEVEL SHIFTER SCDS147 – OCTOBER 2003

<ul> <li>Member of the Texas Instruments Widebus™ Family</li> </ul>	DGG, DGV, OR DL PACKAGE (TOP VIEW)
<ul> <li>Output Voltage Translation Tracks V<sub>CC</sub></li> </ul>	
<ul> <li>Supports Mixed-Mode Signal Operation O All Data I/O Ports</li> </ul>	
- 5-V Input Down To 3.3-V Output Level	1A2 🛛 3 54 🗍 1B1 1A3 🗍 4 53 🗍 1B2
Shift With 3.3-V V <sub>CC</sub> – 5-V/3.3-V Input Down To 2.5-V Output Level Shift With 2.5-V V <sub>CC</sub>	1A4 🛛 5 52 🗍 1B3 1A5 🗍 6 51 🗋 1B4
<ul> <li>5-V Tolerant I/Os With Device Powered-Up or Powered-Down</li> </ul>	
<ul> <li>Bidirectional Data Flow, With Near-Zero Propagation Delay</li> </ul>	1A7 U 9 48 U 1B6 1A8 U 10 47 U 1B7
<ul> <li>Low ON-State Resistance (ron)</li> </ul>	1A9 [] 11 46 [] 1B8 1A10 [] 12 45 [] 1B9
<ul> <li>Characteristics (r<sub>on</sub> = 5 Ω Typical)</li> <li>Low Input/Output Capacitance Minimizes</li> </ul>	1A11 [] 13   44 [] 1B10 1A12 [] 14   43 [] 1B11
Loading ( $C_{io(OFF)} = 5 \text{ pF Typical}$ )	2A1 [ 15 42 ] 1B12 2A2 [ 16 41 ] 2B1
<ul> <li>Data and Control Inputs Provide Undershoot Clamp Diodes</li> </ul>	V <sub>CC</sub> [] 17 40 [] 2B2
<ul> <li>Low Power Consumption (I<sub>CC</sub> = 70 μA Max)</li> </ul>	2A3   18 39   2B3 GND   19 38   GND 2A4   20 37   2B4
• V <sub>CC</sub> Operating Range From 2.3 V to 3.6 V	2A4 [ 20 37 ] 2D4 2A5 [ 21 36 ] 2B5
<ul> <li>Data I/Os Support 0 to 5-V Signaling Level (0.8-V, 1.2-V, 1.5-V, 1.8-V, 2.5-V, 3.3-V, 5-V)</li> </ul>	s 2A6 [ 22 35 ] 2B6 2A7 [ 23 34 ] 2B7
<ul> <li>Control Inputs Can be Driven by TTL or 5-V/3.3-V CMOS Outputs</li> </ul>	2A8 [ 24 33 ] 2B8 2A9 [ 25 32 ] 2B9
<ul> <li>I<sub>off</sub> Supports Partial-Power-Down Mode Operation</li> </ul>	2A10 26 31 2B10 2A11 27 30 2B11
<ul> <li>Latch-Up Performance Exceeds 250 mA P JESD 17</li> </ul>	er 2A12 28 29 2B12 NC – No internal connection

- ESD Performance Tested Per JESD 22

   2000-V Human-Body Model (A114-B, Class II)
  - 1000-V Charged-Device Model (C101)
- Supports Digital Applications: Level Translation, PCI Interface, Bus Isolation
- Ideal for Low-Power Portable Equipment

### description/ordering information

The SN74CB3T16211 is a high-speed TTL-compatible FET bus switch with low ON-state resistance ( $r_{on}$ ), allowing for minimal propagation delay. The device fully supports mixed-mode signal operation on all data I/O ports by providing voltage translation that tracks V<sub>CC</sub>. The SN74CB3T16211 supports systems using 5-V TTL, 3.3-V LVTTL, and 2.5-V CMOS switching standards, as well as user-defined switching levels (see Figure 1).



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description/ordering information (continued)





#### Figure 1. Typical DC Voltage-Translation Characteristics

The SN74CB3T16211 is organized as two 12-bit bus switches with separate ouput-enable (1OE, 2OE) inputs. It can be used as two 12-bit bus switches or as one 24-bit bus switch. When OE is low, the associated 12-bit bus switch is ON, and the A port is connected to the B port, allowing bidirectional data flow between ports. When OE is high, the associated 12-bit bus switch is OFF, and a high-impedance state exists between the A and B ports.

This device is fully specified for partial-power-down applications using Ioff. The Ioff feature ensures that damaging current will not backflow through the device when it is powered down. The device has isolation during power off.

To ensure the high-impedance state during power up or power down, OE should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

TA	PACKAGET		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
		Tube	SN74CB3T16211DL	000740044	
–40°C to 85°C	SSOP – DL	Tape and reel	SN74CB3T16211DLR	CB3T16211	
	TOOOD DOO	Tube	SN74CB3T16211DGG	000740044	
	TSSOP – DGG	Tape and reel	SN74CB3T16211DGGR	CB3T16211	
	TVSOP – DGV	Tape and reel	SN74CB3T16211DGVR	KR211	

### **ORDERING INFORMATION**

<sup>†</sup>Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

#### FUNCTION TABLE (each 12-bit bus switch)

INPUT OE	INPUT/OUTPUT A	FUNCTION
L	В	A port = B port
Н	Z	Disconnect



## logic diagram (positive logic)



simplified schematic, each FET switch (SW)



<sup>‡</sup>EN is the internal enable signal applied to the switch.



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ (see Note 1) Control input voltage range, $V_{IN}$ (see Notes 1 and 2) Switch I/O voltage range, $V_{I/O}$ (see Notes 1, 2, and 3) Control input clamp current, $I_{IK}$ ( $V_{IN} < 0$ )	0.5 V to 7 V 0.5 V to 7 V 50 mA 50 mA
ON-state switch current, I <sub>I/O</sub> (see Note 4) Continuous current through V <sub>CC</sub> or GND terminals	
Package thermal impedance, $\theta_{JA}$ (see Note 5): DGG package	64°C/W
DGV package	
DL package	

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltages are with respect to ground unless otherwise specified.

- 2. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 3. VI and VO are used to denote specific conditions for  $V_{I/O}$ .
- 4. II and IO are used to denote specific conditions for II/O.
- 5. The package thermal impedance is calculated in accordance with JESD 51-7.

### recommended operating conditions (see Note 6)

		MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage	2.3	3.6	V
VIH High-level co	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	5.5	
	High-level control input voltage $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2	5.5	V
V <sub>IL</sub> Low	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0	0.7	
	Low-level control input voltage $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	0.8	V
VI/O	Data input/output voltage	0	5.5	V
TA	Operating free-air temperature	-40	85	°C

NOTE 6: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



# SN74CB3T16211 24-BIT FET BUS SWITCH 2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V TOLERANT LEVEL SHIFTER

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#### TYP<sup>†</sup> PARAMETER **TEST CONDITIONS** MIN MAX UNIT $V_{CC} = 3 V,$ -1.2 V VIK $I_{I} = -18 \text{ mA}$ VOH See Figures 3 and 4 V<sub>CC</sub> = 3.6 V, μΑ Control inputs IIN ±10 VIN = 3.6 V to 5.5 V or GND $V_{I} = V_{CC} - 0.7 V \text{ to } 5.5 V$ ±20 $V_{CC} = 3.6 V_{,}$ $V_{I} = 0.7 \text{ V}$ to $V_{CC} - 0.7 \text{ V}$ -40 Switch ON, μΑ ų $V_{IN} = V_{CC}$ or GND ±5 $V_{I} = 0$ to 0.7 V $V_{CC} = 3.6 V_{,}$ $V_0 = 0$ to 5.5 V, loz‡ $V_{I} = 0,$ μΑ ±10 Switch OFF. $V_{IN} = V_{CC} \text{ or } GND$ $V_{CC} = 0,$ $V_{O} = 0$ to 5.5 V, 10 μΑ loff $V_{I} = 0,$ $V_{CC} = 3.6 V,$ $V_I = V_{CC} \text{ or } GND$ 70 $I_{I/O} = 0,$ μΑ ICC Switch ON or OFF, 70 VI = 5.5 V $V_{IN} = V_{CC}$ or GND $V_{CC} = 3 V \text{ to } 3.6 V,$ One input at V<sub>CC</sub> – 0.6 V, ∆ICC§ Control inputs 300 μΑ Other inputs at V<sub>CC</sub> or GND V<sub>CC</sub> = 3.3 V, pF Cin Control inputs 4 $V_{IN} = V_{CC} \text{ or } GND$ V<sub>CC</sub> = 3.3 V, V<sub>I/O</sub> = 5.5 V, 3.3 V, or GND, 5 pF Cio(OFF) Switch OFF, $V_{IN} = V_{CC}$ or GND $V_{CC} = 3.3 V,$ $V_{I/O} = 5.5 \text{ V or } 3.3 \text{ V}$ 5 Switch ON. pF Cio(ON) $V_{I/O} = GND$ 13 $V_{IN} = V_{CC}$ or GND V<sub>CC</sub> = 2.3 V, $I_{O} = 24 \text{ mA}$ 5 9.5 TYP at $V_{CC} = 2.5 V$ , $I_{O} = 16 \text{ mA}$ 5 9.5 $V_{I} = 0$ ron¶ Ω

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

 $V_{IN}$  and  $I_{IN}$  refer to control inputs.  $V_I$ ,  $V_O$ ,  $I_I$ , and  $I_O$  refer to data pins.

 $V_{CC} = 3 V,$  $V_I = 0$ 

<sup>†</sup> All typical values are at  $V_{CC} = 3.3$  V (unless otherwise noted),  $T_A = 25^{\circ}$ C.

<sup>‡</sup> For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

§ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

¶ Measured by the voltage drop between A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

 $I_{O} = 64 \text{ mA}$ 

 $I_{O} = 32 \text{ mA}$ 



5

5

8.5

8.5

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#### switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO	V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
		(OUTPUT)	MIN	MAX	MIN	MAX	
t <sub>pd</sub> †	A or B	B or A		0.15		0.25	ns
t <sub>en</sub>	OE	A or B	1	12	1	10	ns
<sup>t</sup> dis	OE	A or B	1	7.5	1	8.5	ns

<sup>†</sup> The propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).



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### PARAMETER MEASUREMENT INFORMATION



TEST	VCC	S1	RL	VI	сL	$v_\Delta$
<sup>t</sup> pd(s)	$\begin{array}{c} \textbf{2.5 V} \pm \textbf{0.2 V} \\ \textbf{3.3 V} \pm \textbf{0.3 V} \end{array}$	Open Open	<b>500</b> Ω <b>500</b> Ω	3.6 V or GND 5.5 V or GND	30 pF 50 pF	
tpLZ/tpZL	$\begin{array}{c} \textbf{2.5 V} \pm \textbf{0.2 V} \\ \textbf{3.3 V} \pm \textbf{0.3 V} \end{array}$	$\begin{array}{c} 2 \times \mathbf{V}_{\mathbf{C}\mathbf{C}} \\ 2 \times \mathbf{V}_{\mathbf{C}\mathbf{C}} \end{array}$	<b>500</b> Ω <b>500</b> Ω	GND GND	30 pF 50 pF	0.15 V 0.3 V
<sup>t</sup> PHZ <sup>/t</sup> PZH	$\begin{array}{c} \textbf{2.5 V} \pm \textbf{0.2 V} \\ \textbf{3.3 V} \pm \textbf{0.3 V} \end{array}$	Open Open	<b>500</b> Ω <b>500</b> Ω	3.6 V 5.5 V	30 pF 50 pF	0.15 V 0.3 V



NOTES: B. CL includes probe and jig capacitance.

C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

D. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>Q</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns.

- E. The outputs are measured one at a time with one transition per measurement.
- F.  $t_{PI 7}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- G. tpzL and tpzH are the same as ten.
- H. tpLH and tpHL are the same as tpd(s). The tpd propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).
- I. All parameters and waveforms are not applicable to all devices.





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### **TYPICAL CHARACTERISTICS**



Figure 3. Data Output Voltage vs Data Input Voltage



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### **TYPICAL CHARACTERISTICS (continued)**



ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Falls within JEDEC MO-225 variation BA.

D. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).



# **MECHANICAL DATA**

PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

### DGV (R-PDSO-G\*\*)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



# **MECHANICAL DATA**

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

#### PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

DL (R-PDSO-G\*\*)



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118



# **MECHANICAL DATA**

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

### DGG (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

**48 PINS SHOWN** 



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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